





#### SURFACE MOUNT FAST SWITCHING DIODE

### **Features**

- Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Leads: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.004 grams (approximate)

#### **SOD323**



Top View

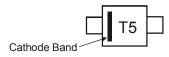
## Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
1N4448HWS-7-F	Commercial	SOD323	3,000/Tape & Reel
1N4448HWSQ-7-F	Automotive	SOD323	3,000/Tape & Reel
1N4448HWS-13-F	Commercial	SOD323	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

## **Marking Information**



T5 = Product Type Marking Code

### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	$V_{RM}$	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	80	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	57	V
Forward Continuous Current	I <sub>FM</sub>	500	mA
Average Rectified Output Current	Io	250	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0x	I <sub>FSM</sub>	4.0 1.0	А

### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_{D}$	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	$T_J,T_STG$	-65 to +150	°C

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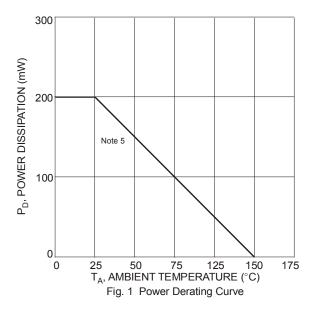


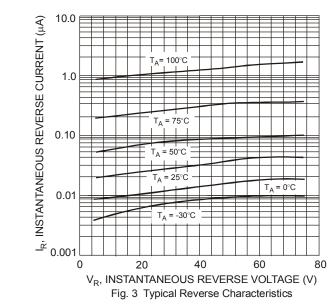
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

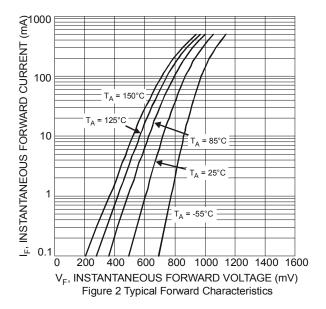
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{BR(R)}$	80	_	V	I <sub>R</sub> = 100μA
	V <sub>FM</sub>	0.62	0.72	V	I <sub>F</sub> = 5.0mA
Forward Voltage		_	0.855		I <sub>F</sub> = 10mA
roiwaru voitage		_	1.0		I <sub>F</sub> = 100mA
			1.25		I <sub>F</sub> = 150mA
			100	nA	V <sub>R</sub> = 80V
Peak Reverse Current (Note 6)	1		50	μA	$V_R = 75V, T_J = +150^{\circ}C$
reak Reverse Current (Note 6)	I <sub>RM</sub>	_	30	μA	$V_R = 25V, T_J = +150^{\circ}C$
			25	nA	V <sub>R</sub> = 20V
Total Capacitance	C <sub>T</sub>		3.5	pF	$V_R = 0$ , $f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>		4.0	ns	$I_F = I_R = 10 \text{mA},$
Reverse Recovery Time	ιπ				$I_{rr} = 0.1 \times I_{R}, R_{L} = 100\Omega$

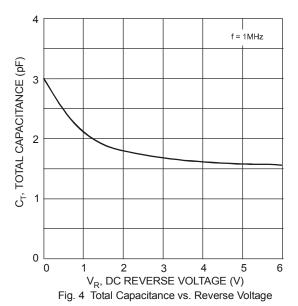
Notes:

- 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.











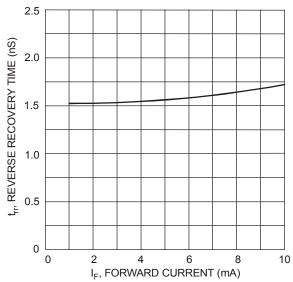
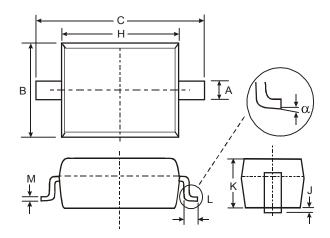


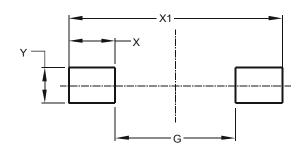
Fig. 5 Reverse Recovery Time vs. Forward Current

# **Package Outline Dimensions**



SOD323			
Dim	Min	Max	
Α	0.25	0.35	
В	1.20	1.40	
С	2.30	2.70	
Н	1.60	1.80	
J	0.00	0.10	
K	1.0	1.1	
L	0.20	0.40	
М	0.10	0.15	
α	0°	8°	
All Dimensions in mm			

# **Suggested Pad Layout**



Dimensions	Value (in mm)
G	1.520
Х	0.590
X1	2.700
Υ	0.450



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